

## Excellent Integrated System Limited

Stocking Distributor

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[Diodes Incorporated](#)  
[PDS1040-13](#)

For any questions, you can email us directly:

[sales@integrated-circuit.com](mailto:sales@integrated-circuit.com)



**PDS1040**

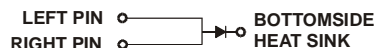
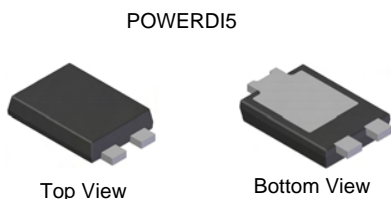
**10A SCHOTTKY BARRIER RECTIFIER  
POWERDI®**

**Features**

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Forward Voltage Drop
- Very Low Leakage Current
- High Forward Surge Current Capability
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

**Mechanical Data**

- Case: POWERDI5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 **(e3)**
- Polarity: See Diagram
- Weight: 0.096 grams (approximate)



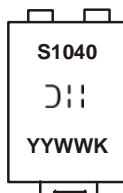
**Note:** Pins Left & Right must be electrically connected at the printed circuit board.

**Ordering Information** (Note 4)

Part Number	Case	Packaging
PDS1040-13	POWERDI5	5000/Tape & Reel
PDS1040-7	POWERDI5	1500/Tape & Reel
PDS1040Q-13	POWERDI5	5000/Tape & Reel
PDS1040Q-7	POWERDI5	1500/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com>.

**Marking Information**



- S1040 = Product type marking code
- ⌋⌋ = Manufacturers' code marking
- YYWW = Date code marking
- YY = Last two digits of year (ex: 04 for 2004)
- WW = Week code (01 - 53)
- K = Factory designator

### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	40	V
Working Peak Reverse Voltage	V <sub>RWM</sub>		
DC Blocking Voltage	V <sub>R</sub>		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	28	V
Average Rectified Output Current (see also Figure 5)	I <sub>O</sub>	10	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	275	A

### Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	R <sub>θJS</sub>	—	1.5	°C/W
Thermal Resistance Junction to Ambient Air (Note 5)	R <sub>θJA</sub>	95	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 6)	R <sub>θJA</sub>	75	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 7)	R <sub>θJA</sub>	50	—	°C/W
Operating Junction Temperature Range V <sub>R</sub> ≤ 80% V <sub>RRM</sub> V <sub>R</sub> ≤ 50% V <sub>RRM</sub>	T <sub>J</sub>	-65 to +150 -65 to +180		°C
Storage Temperature Range	T <sub>STG</sub>	-65 to +150		°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	V <sub>(BR)R</sub>	40	—	—	V	I <sub>R</sub> = 1mA
Forward Voltage	V <sub>F</sub>	—	0.45	0.49	V	I <sub>F</sub> = 8A, T <sub>S</sub> = +25°C
		—	0.47	0.51		I <sub>F</sub> = 10A, T <sub>S</sub> = +25°C
		—	—	0.41		I <sub>F</sub> = 8A, T <sub>S</sub> = +125°C
		—	0.42	0.49		I <sub>F</sub> = 10A, T <sub>S</sub> = +125°C
Reverse Leakage Current (Note 8)	I <sub>R</sub>	—	0.02	0.3	mA	T <sub>S</sub> = +25°C, V <sub>R</sub> = 35V
		—	5.5	25		T <sub>S</sub> = +100°C, V <sub>R</sub> = 35V
		—	0.03	0.7		T <sub>S</sub> = +25°C, V <sub>R</sub> = 40V
		—	6.5	50		T <sub>S</sub> = +100°C, V <sub>R</sub> = 40V

- Notes:
5. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.
  6. Polyimide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.
  7. Polyimide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
  8. Short duration pulse test used to minimize self-heating effect.
  9. Polyimide PCB, 2 oz. Copper. Cathode pad dimensions 18.8mm x 14.4mm. Anode pad dimensions 5.6mm x 3.0mm.
  10. Devices mounted such that R<sub>θJA</sub> = 19°C/W.



**PDS1040**

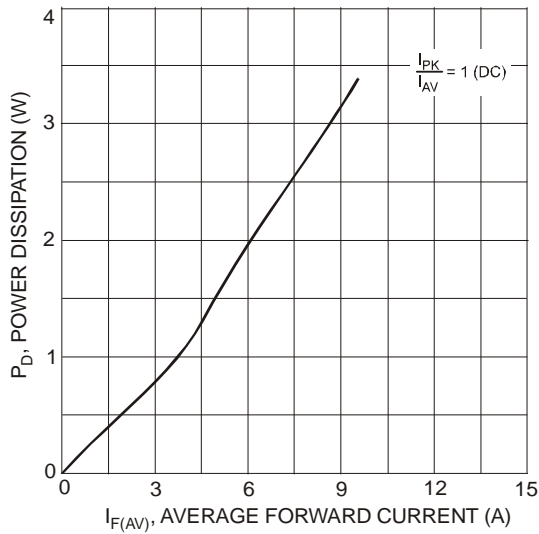


Fig. 1 Forward Power Dissipation

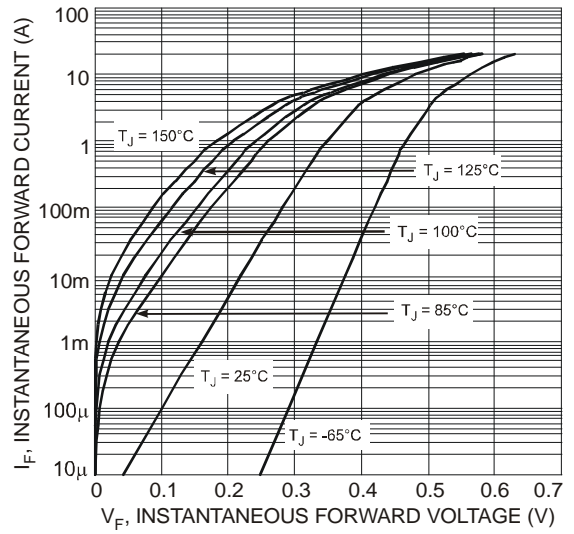


Fig. 2 Typical Forward Characteristics

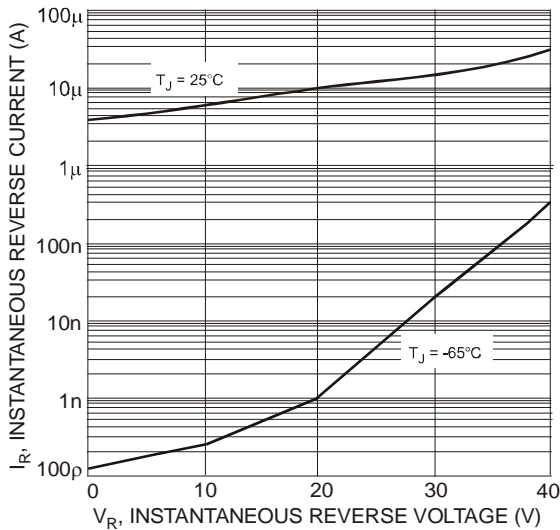


Fig. 3 Typical Reverse Characteristics

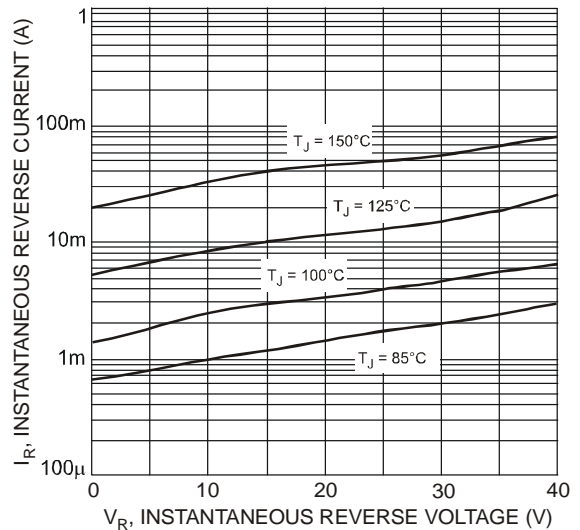


Fig. 4 Typical Reverse Characteristics

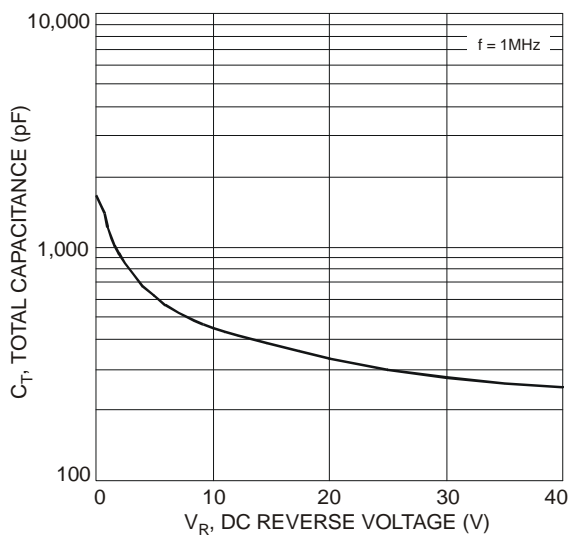


Fig. 5 Total Capacitance vs. Reverse Voltage

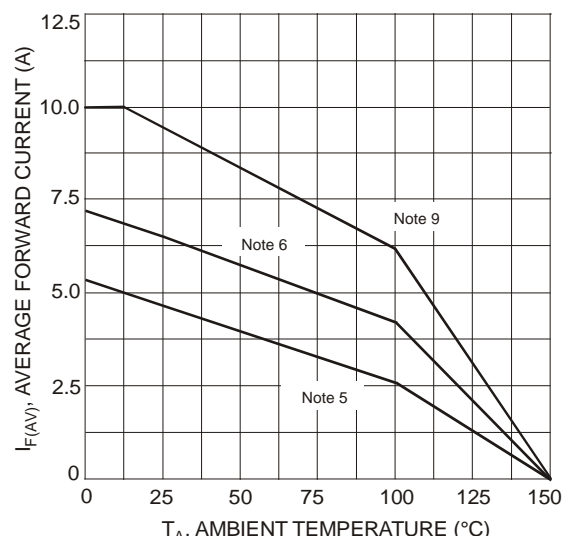


Fig. 6 Forward Current Derating Curve



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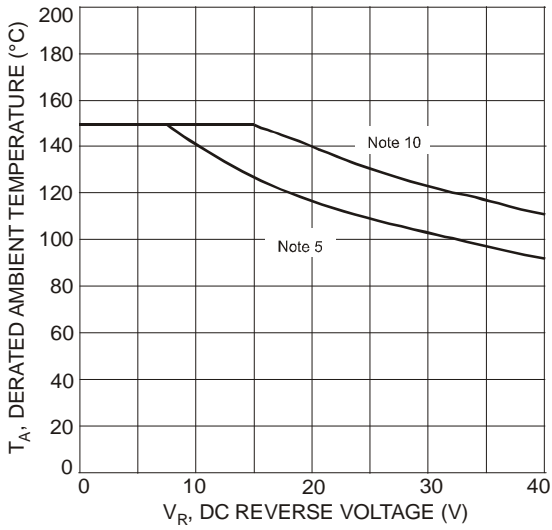
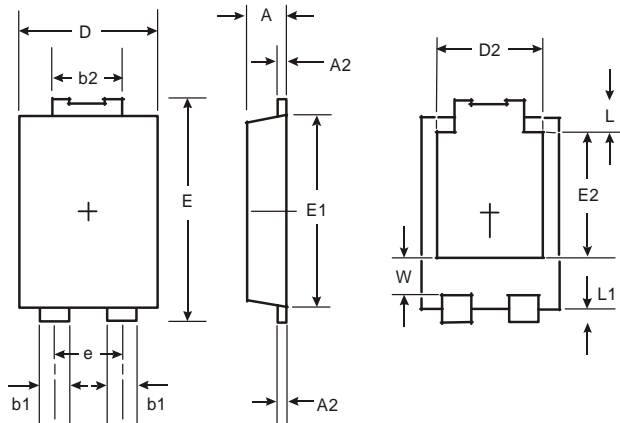


Fig. 7 Operating Temperature Derating

**Package Outline Dimensions**

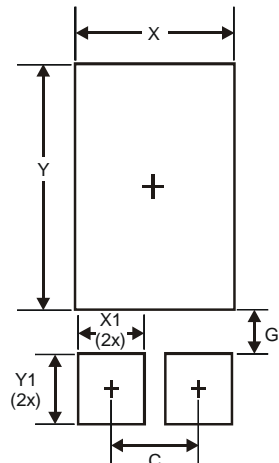
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



POWERDI <sup>®</sup> 5		
Dim	Min	Max
A	1.05	1.15
A2	0.33	0.43
b1	0.80	0.99
b2	1.70	1.88
D	3.90	4.05
D2	3.054 Typ	
E	6.40	6.60
e	1.84 Typ	
E1	5.30	5.45
E2	3.549 Typ	
L	0.75	0.95
L1	0.50	0.65
W	1.10	1.41
<b>All Dimensions in mm</b>		

**Suggested Pad Layout**

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	1.840
G	0.852
X	3.360
X1	1.390
Y	4.860
Y1	1.400



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